# Ersa ECOSELECT 4

Inline and batch selective soldering system for highest selective soldering quality





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# **Highlights ECOSELECT 4**

- Flexibly integrable soldering system: inline or batch operation
- VERSAFLOW 4 technology
- PCB size 508 x 508 mm
- Roller conveyor
- Up to two spray heads and flux tanks
- Power convection
- Y/Z variable dual solder pots
- Automatic nozzle activation
- Upgrade with independent flux module to a full inline machine
- Award-winning ERSASOFT 5 software
- VERSACAM solder wave height measurement "on the fly"

The **ECOSELECT 4** is Ersa's newest selective soldering system. It is a compact system that is perfectly suited for small up to medium-sized batches where flexibility is essential.

The ECOSELECT 4 features machine technology of the latest VERSAFLOW generation. Its conveyor system is a high-quality roller conveyor for a max. PCB size of 508 x 508 mm. The ECOSELECT 4 can be used inline or in batch operation. Another machine highlight is the new power convection heating, for example, which provides an optimal and homogenous warm-up also of complex boards. Like all Ersa selective soldering systems the ECOSELECT 4 is equipped

with a programmable precision spray fluxer with integrated spray control for precise and economical flux application in single spots or in tracks. A second spray head is available as an option.

The new dual solder pot system of the VERSAFLOW 4 is also available for the ECOSELECT 4. Both Miniwave pots can be moved flexibly in Y/Z direction. Thus, the machine operator can install solder nozzles with different diameters in order to quickly solder connectors using a nozzle with large diameter and using a very slim nozzle shape for joints which are difficult to reach.



Soldering system for inline or batch operation



Roller conveyor



# **Basic configuration**

- 3 axis positioning system
- Max. PCB size 508 x 508 mm
- Solder module with low-maintenance electromagnetic solder pump
- Exhaust control
- Status indication lights
- Process visualization incl. soldering protocols, process data recording, monitoring function, indication of maintenance and errors
- Roller conveyor
- Conveyor width adjustment
- Infeed/outfeed module
- High-precision spray fluxer
- Lead-free single point solder module with solder level monitoring and wave height measurement

The innovative and user-friendly ERSASOFT 5 software renders machine operation even more intuitive. Through individual user interfaces, each group of operators receives, at one glance, the data and information it requires. A further software highlight is the PiP technology (picture in picture) combined with a process monitoring camera.



Power convection heating



Y/Z variable dual solder pots

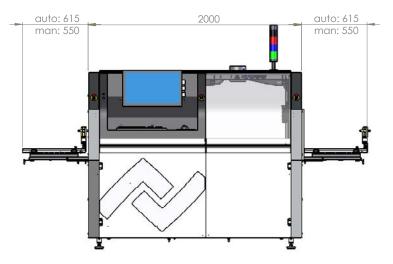


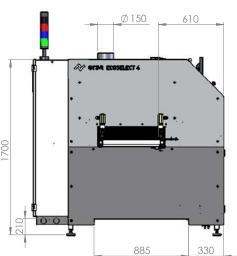
Automatic nozzle activation



ERSASOFT 5

# Technical data ECOSELECT 4





# ECOSELECT 4 (basic system)

Length:	2,000 mm
Width:	1,800 mm
Height:	1,700 mm
Weight:	1,200 kg
Туре:	batch/inline
PCB loading:	manual/automatic

#### **Conveyor system**

Туре:	roller conveyor
PCB width:	50 – 508 mm
	(single track)
PCB length:	127 – 508 mm
Clearance from PCB edg	ge: 3 mm
PCB top side clearance:	max. 120 mm
PCB bottom side clearand	ce: max. 60 mm
Speed:	0.2 – 15 m/min
Mask/PCB weight: (heavy load cor	15 kg nveyor optional)

# Flux module

Туре:	high-prec	ision spray fluxer
Positioning	,	2 axis, ervo motor driven
Flux storag	e tank:	1,8
Positioning	speed:	1 – 400 mm/s
Fluxer spee	d:	20 mm/s
Positioning	accuracy:	±0,15 mm
Spray width	ı: 2 – 8 mn	n (130 µm nozzle)

# Preheat module

Туре:	IR bottom-side (basis),
to	p-side convection (option),
top side	e power convection (option)
Power:	12 kW per IR heater,
	5 kW (convection),
	6 kW (power convection)
Temperature	e: 200 °C

# Miniwave solder module

Solder wave height:	max. 5 mm
Clearance from PCE	B edge: min. 3 mm
Solder volume: app	3 .
appro	ox. 12 kg (lead-free)
Solder temperature	: max. 330 °C
Warm-up time:	75 min to 280 °C
Positioning speed:	X/Y; 2 – 200 mm/s
Soldering speed:	10 mm/s
Positioning accurac	y: ±0,15 mm

# Nitrogen technology

Nitrogen supply:	to be supplied locally
Nitrogen injection	$\begin{array}{cc} & & N_2 \ cover \\ & \text{over the solder bath} \end{array}$
Required pressure	e: 6 bar
Consumption:	approx. 1.5 m³/h
	per pot
Particle cleanlines	

# Compressed air

Compressed air supply:	to be supplied
	locally
Required pressure:	6 bar
Consumption :	< 5 m³/h

# **Electrical data**

Power:	5-wire system, 3 x 230/400 V, N, PE
Power tolerance ra	inge: ±5 %
Frequency:	50/60 Hz
Power consumptio	n: 22 kW
(incl. bottom side preheating)	
Safety fuse:	3 x 35 A

# **Exhaust rating**

Exhaust stacks:	1 pc., (	OD 150 mm
Exhaust volume per	stack:	350 m³/h

# Environmental specs/noise level

Ambient temperature:	15 – 35 °C
Permanent sound level:	<60 dB(A)

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